P E FORM PTO-1449

INFER MATION

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO. MICRON.084C1C1 APPLICATION NO. 10/634,134

INFERMATION DISCLOSURE STATEMENT
BY APPLICANT

USE SEVERAL SHEETS IF NECESSARY)

APPLICANT Jiang et al.

FILING DATE August 4, 2003 GROUP

2823

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL	T	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
SAG	1.	781,230	01/31/05	Rodman			
JAG	2.	2,935,420	05/03/60	Linden	-		
JH	3.	3,339,526	9/05/67	Bradley et al.			
PAG	4.	3,839,037	10/1/74	Fromson			
SAG	5.	3,923,541	12/2/75	Healy			
JAG	6.	3,930,465	01/06/76	Schuierer			
DAG	7.	3,990,926	11/9/76	Konicek	1		
JAG	8.	4,113,899	9/12/78	Henry et al.			
SAC	9.	4,282,271	8/4/81	Feldstein			
SAG	10.	4,364,975	12/82	Cork et al.	1		
24	11.	4,474,311	10/02/84	Petrecca			
DAT.	12.	4,603,656	08/05/86	Jaye, Jr.			
AG	13.	4,762,601	9/9/88	Krulik et al.			
JAC	14.	4,772,496	9/20/88	Maeda et al.	_		
SAG	15.	4,913,082	4/3/90	Silbermann et al.			·
SH	16.	4,938,850	7/3/90	Rothschild et al.			
JAC	17.	5,028,454	7/2/91	Lytle et al.			
AG	18.	5,118,362	7/2/92	St. Angelo et al.	_		
JAC	19.	5,194,313	3/16/93	Hupe et al.			
J/E	20.	5,206,052	4/27/93	Nakaso et al.	_		
SH	21.	5,262,041	11/16/93	Gulla			
JAG	22.	5,342,501	08/94	Okabayashi			
SAE	23.	5,441,629	08/95	Kosaki			
JAC	24.	5,458,819	10/10/95	Lashmore et al.			
JA	25.	5,492,863	2/20/96	Higgins, III			
JAC.	26.	5,500,106	3/19/98	Goldberg	_		
SAG	27.	5,512,131	04/98	Kumar et al.			

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DATE CONSIDERED

July 29 2004

*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.

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APPLICATION NO. 10/634,134 # PTO-1449 ATTY. DOCKET NO. U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE MICRON.084C1C1 INF MATION DISCLOSURE STATEMENT BY APPLICANT **APPLICANT** Jiang et al. USE SEVERAL SHEETS IF NECESSARY) FILING DATE GROUP 2823 August 4, 2003 **Unknown**

	U.S. PATENT DOCUMENTS						
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
MG	28.	5,583,073	12/10/96	Lin et al.	_		
JAG	29.	5,603,849	2/18/97	u			
JAG	30.	5,618,634	4/8/97	Hosoda et al.	_		
JAG	31.	5,725,807	03/98	Thorn et al.			
JAG	32.	5,810,940	9/22/98	Fukazawa et al.	_		
SAG	33.	5,897,368	04/99	Cole, Jr. et al.	-		
DAT	34.	5,911,865	6/15/99	Yih			_
SAG	35.	5,925,931	7/20/99	Yamamoto			

EXAMINER INITIAL		OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)
SAG	36.	K. Baudrand, J. Bengston, "Electroless Plating Processes - Developing Technologies for Electroless Nickel, Palladium, and Gold," Metal Finishing, Sept. 1995, pp.55-57.
JAG	37.	W.J. Hawk, "Electroless Palladium for Electronics," Metal Finishing, March 1986, pp.11-12.
SAG	38.	J.K. Llm, J.S. Russo, E. Antonier, "Electroplated Palladium Coating As a Nickel Migration (Thermal) Barrier," Plating and Surface Finishing, March 1996, pp.64-67.
DAG	39.	H. Nawafune, S. Mizumoto, M. Haga, E. Uchida, "Electroless Palladium Plating from an Ethylenediamine Complex Bath using Phosphite as a Reducing Agent," Transactions of the Institute of Metal Finishing, Vol. 74, #1, pp.21-24.
JAG	40.	Rao, "Multilevel Interconnect Technology," Chapter: Manufacturing, p.141. (Jake Unknown)
JAG	41.	P. Steinmetz, S. Alperine, A. Friant-Costantini, P. Josso, "Electroless Deposition of Pure Nickel, Palladium and Platinum," Surface and Coatings Technology, 43/44 (1990), pp. 500-510.

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